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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





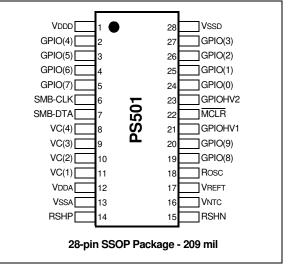
# **PS501**

## Single Chip Field Reprogrammable Battery Manager

## Features

- Single chip solution for rechargeable battery management
- · Footprint compatible with PS401
- SMBus 1.1 and SBData 1.1 compatible
- Precise capacity reporting for Lithium Ion and Lithium Polymer battery chemistries
- Embedded PowerSmart<sup>®</sup> patented algorithms contained in customizable on-chip 16-Kbyte Flash memory
- User configurable and "learned" parameters stored in on-chip 256 x 8 EEPROM
- Algorithms and parameters fully field reprogrammable via SMBus interface
- Integrating sigma-delta A/D converter with 9 to 16-bit programmable resolution which accurately measures:
  - Current through sense resistor
  - High-voltage (18V) battery cells directly connected to VCELL inputs
  - Temperature measurement from on-chip sensor or optional external thermistor
- · Integrated precision silicon time base
- Twelve individually programmable input/output pins that can be assigned as charge control I/O, secondary safety function I/O, SOC LED output or general purpose I/O
  - Two of the twelve I/Os are high voltage, capable for direct drive of Charge and Safety FETs
- On-chip regulator generates precision digital and analog supply voltages directly from pack voltage
- Supports direct connection to 2 to 4-cell Lithium packs
- Flexible power operating modes:
  - Run: Continuous operation
  - Sample: Periodic measurements at programmable intervals
  - Sleep: Shutdown mode due to low voltage. Power consumption less than 25  $\mu A.$
  - Shelf-Sleep: Shuts off PS501 power consumption for pack storage with automatic wake-up on pack insertion. Power consumption is less than 1 μA.
- Integrated Reset Control
  - Power-on Reset
  - Watchdog Timer Reset
  - Brown-out Detection Reset

## Pin Description



## **Pin Summary**

Pin Name	Туре	Description
VDDD, VSSD	Supply	Digital supply voltage input, ground
GPIO(09)	I/O	Programmable digital I/O
GPIOHV1,2	I/O	Open-drain programmable digital I/O for direct drive of FETs
MCLR	Ι	Master Clear. Pull-up in normal operation
SMB-CLK, SMB-DTA	I/O	SMBus interface
VC(14)	I	Cell voltage inputs
Vdda, Vssa	Supply	Voltage regulator output (internally connected to analog supply input), ground
RSHP, RSHN	I	Current sense resistor input
VNTC	Ι	External thermistor input
VREFT	0	Thermistor reference voltage
Rosc	I	Internal oscillator bias resistor

## 1.0 PRODUCT OVERVIEW

The PS501 combines a high-performance, low-power Microchip PIC18 microcontroller core together with PowerSmart proprietary monitoring/control algorithms and 3D cell models stored in 16 Kbytes of on-chip reprogrammable Flash memory.

Analog resources include a 16-bit sigma-delta integrating A/D and mixed signal circuitry for precision measurement of battery current, temperature and voltage and for direct connection to 4-cell series Lithium lon packs. On-chip EEPROM is provided for storage of user customizable and "learned" battery parameters. An industry standard 2-wire SMBus interface supports host communication using standard SBData commands and status.

Additional integrated features include a high accuracy on-chip oscillator and temperature sensor. Twelve general purpose pins support charge or safety control or user programmable digital I/O. Eight of them can be used as LED drivers and two are open drain for direct FET drive.

The PS501 can be configured to accommodate all Lithium rechargeable battery chemistries, including Li lon graphite, Li lon hard carbon and Li lon polymer, with direct connection to 2 to 4 series cell configurations.

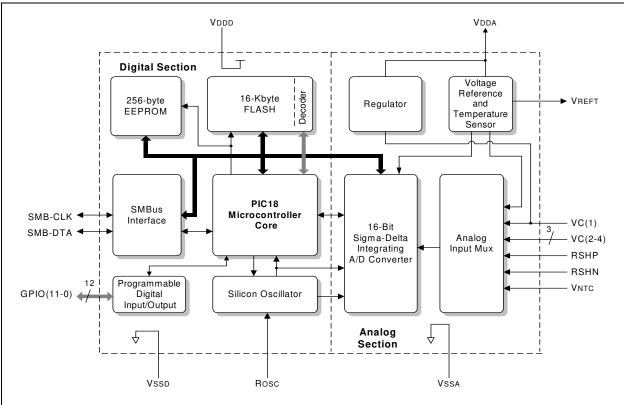


FIGURE 1-1: PS501 INTERNAL BLOCK DIAGRAM

## 1.1 Architectural Description

The PS501 is a a fully field reprogrammable single chip solution for rechargeable battery management. Figure 1-1 is an internal block diagram highlighting the major architectural elements described below.

## 1.2 Microcontroller/Memory

The PS501 incorporates an advanced, low-power Microchip PIC18 8-bit RISC microcontroller core. Memory resources include 16 Kbytes of reprogrammable Flash memory for program/data storage and 256 bytes of EEPROM for parameter storage. Both memory arrays may be reprogrammed through the SMBus interface.

## 1.3 A/D Converter

The PS501 performs precise measurements of current, voltage and temperature, using a highly accurate 16-bit integrating sigma-delta A/D converter. The A/D can be calibrated to eliminate gain and offset errors and incorporates an auto-zero offset correction feature that can be performed while in the end system application.

## 1.4 PowerSmart<sup>®</sup> Firmware/Battery Models

Contained within the 16-Kbyte Flash memory is the PowerSmart developed battery management firmware that incorporates proprietary algorithms and sophisticated 3-dimensional cell models. Developed by battery chemists, the patented, self-learning 3D cell models contain over 250 parameters and compensate for selfdischarge, temperature and other factors. In addition, multiple capacity correction and error reducing functions are performed during charge/discharge cycles to enhance accuracy and improve fuel gauge and charge control performance. As a result, accurate battery capacity reporting and run-time predictions with less than 1% error are achievable.

The reprogrammability of the Flash allows firmware upgrades and customized versions to be rapidly created without the need for silicon revisions.

The PS501 can be easily customized for a particular application's battery cell chemistry. Standard configuration files are provided by PowerSmart for a wide variety of popular rechargeable cells and battery pack configurations.

## 1.5 SMBus Interface/SBData Commands

Communication with the host is fully compliant with the industry standard Smart Battery System (SBS) specification. Included is an advanced SMBus communications engine that is compliant with the SMBus v1.1 protocols. The integrated firmware processes all the revised Smart Battery Data (SBData) v1.1 values.

## 1.6 Accurate Integrated Time Base

The PS501 integrates a highly accurate silicon oscillator that provides accurate timing for self-discharge and capacity calculations and eliminates the need for an external crystal.

## 1.7 Temperature Sensing

An integrated temperature sensor is provided to minimize component count when the PS501 IC is located in close physical proximity to the battery cells being monitored. As an option, a connection is provided for an external thermistor that can also be monitored.

## 1.8 General Purpose I/O

Twelve programmable digital input/output pins are provided by the PS501. Eight of these pins can be used as LED outputs to display State-Of-Charge (SOC), used for direct control of external charge circuitry or to provide additional levels of safety in Li lon packs. Alternatively, they can be used as general purpose input/outputs. Two of the I/Os are open-drain outputs and can thus be used to directly drive FETs or other high-voltage applications.

Pin	Name	Description
1	Vddd	(Input) Filter capacitor input for digital supply voltage.
2	GPIO(4)	(Bidirectional) Programmable general purpose digital input/output pin (4) or LED driver.
3	GPIO(5)	(Bidirectional) Programmable general purpose digital input/output pin (5) or LED driver.
4	GPIO(6)	(Bidirectional) Programmable general purpose digital input/output pin (6) or LED driver.
5	GPIO(7)	(Bidirectional) Programmable general purpose digital input/output pin (7) or LED driver.
6	SMB-CLK	SMBus clock pin connection.
7	SMB-DTA	SMBus data pin connection.
8	VC(4)	(Input) Cell voltage input for the fourth highest voltage cell in a series string.
9	VC(3)	(Input) Cell voltage input for the third highest voltage cell in a series string.
10	VC(2)	(Input) Cell voltage input for the second highest voltage cell in a series string.
11	VC(1)	(Input) Cell voltage input for the first or highest voltage cell in a series string.
12	Vdda	(Input) Analog supply voltage input.
13	VSSA	Analog ground reference point.
14	RSHP	(Input) Current measurement A/D input from positive side of the current sense resistor.
15	RSHN	(Input) Current measurement A/D input from negative side of the current sense resistor.
16	VNTC	(Input) A/D input for use with an external temperature circuit. This is the midpoint connection of a voltage divider, where the upper leg is a thermistor (103ETB type) and the lower leg is a 3.65 KOhm resistor. This input should not go above 150 mV.
17	VREFT	(Output) Reference voltage output for use with temperature measuring A/D circuit. This 150 mV output is the top leg of the voltage divider and connects to an external thermistor
18	Rosc	External bias resistor.
19	GPIO(8)	(Bidirectional) Programmable general purpose digital input/output pin (8).
20	GPIO(9)	(Bidirectional) Programmable general purpose digital input/output pin (9).
21	GPIOHV1	(Bidirectional) Programmable general purpose digital input/output pin (10). Open-drain, high-voltage tolerant.
22	MCLR	(Input) Master Clear. Must be pulled up for normal operation.
23	GPIOHV2	(Bidirectional) Programmable general purpose digital input/output pin (12). Open-drain, high-voltage tolerant.
24	GPIO(0)	(Bidirectional) Programmable general purpose digital input/output pin (0) or LED driver.
25	GPIO(1)	(Bidirectional) Programmable general purpose digital input/output pin (1) or LED driver.
26	GPIO(2)	(Bidirectional) Programmable general purpose digital input/output pin (2) or LED driver.
27	GPIO(3)	(Bidirectional) Programmable general purpose digital input/output pin (3) or LED driver.
28	VSSD	Digital ground reference point.

## TABLE 1-1: PIN DESCRIPTIONS

## 2.0 A/D OPERATION

The PS501 A/D converter measures current, voltage and temperature and integrates the current over time to predict State-Of-Charge. Pack voltage and individual cell voltages are monitored and can be individually calibrated for the best accuracy. Using an external sense resistor, current is monitored during both charge and discharge and is integrated over time using the on-chip oscillator as the time base. Temperature is measured from the on-chip temperature sensor or an optional external thermistor. Current and temperature are also calibrated for accuracy.

## 2.1 A/D Converter List

The A/D converter alternately measures pack voltage, cell voltages, current, temperature and auto-offset as explained below. The schedule for the sequence and frequency of these measurements is programmable, as is the number of bits used. The default scheduling uses three lists. At near full (above the voltage point **ADLNearFull**) and near empty (below the voltage point **ADLNearEmpty**), voltage intensive lists are used to accurately end charge or discharge. In between **ADLNearFull** and **ADLNearEmpty**, a current intensive schedule is used to more accurately calculate capacity.

## 2.2 Current Measurement

The A/D input channels for current measurement are the RSHP and RSHN pins. The current is measured using an integrating method, which averages over time to get the current measurement and integrates over time to get a precise measurement value.

A 5 to 600 milli-Ohm sense resistor is connected to RSHP and RSHN as shown in the example schematic. The maximum input voltage at either RSHP or RSHN is +/-150 mV. The sense resistor should be properly sized to accommodate the lowest and highest expected charge and discharge currents, including suspend and/or standby currents.

Circuit traces from the sense resistor should be as short as practical without significant crossovers or feedthroughs. Failure to use a single ground reference point at the negative side of the sense resistor can significantly degrade current measurement accuracy.

The EEPROM value, **NullCurr**, represents the zero zone current of the battery. This is provided as a calibration guardband for reading zero current. Currents below the +/- **NullCurr** (in mA) limit are read as zero and are not included in the capacity algorithm calculations. A typical value for **NullCurr** is 3 mA, so currents between -3 mA and +3 mA will be reported as zero and not included in the capacity calculations.

The equation for current measurement resolution and sense resistor selection is shown in the following equation.

#### **EQUATION 2-1:**

9.15 mV/RSENSE (milli-Ohms) = Current LSB (Minimum current measurement if > **NullCurr**)

Current LSB x 16384 = Maximum current measurement possible

In-circuit calibration of the current is done using the SMBus interface at time of manufacture to obtain absolute accuracy. The current measurement equation is:

#### EQUATION 2-2:

 $I(ma) = (I_A/D - COCurr) * CFCurr/16384$ 

where:

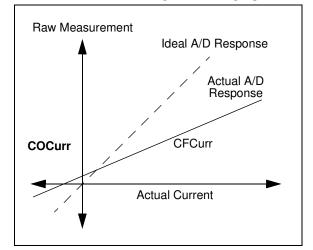
I\_A/D is the internal measurement

**COCurr** is the "Correction Offset for Current" which compensates for any offset error in current measurement stored in EEPROM.

**CFCurr** is the "Correction Factor for Current" which compensates for any variances in the actual sense resistance over varying currents stored in EEPROM.

Figure 2-1 shows the relationship of the **COCurr** and **CFCurr** values.

#### FIGURE 2-1: COCurr AND CFCurr VALUE RELATIONSHIP



## 2.3 Auto-Offset Compensation

Accuracy drift is prevented using an automatic autozero self-calibration method, which 're-zeroes' the current measurement circuit every AOMInt \* 0.5 seconds when enabled. This feature can correct for drift in temperature during operation. The auto-offset compensation circuit works internally by disconnecting the RSHP and RSHN inputs and internally shorting these inputs to measure the zero input offset. The EEPROM and calibration value COD is the true zero offset value of the particular module.

## 2.4 Voltage Measurements

The A/D input channels for cell and pack voltage measurements are the VC(1) to VC(4) pins. Measurements are taken each measurement period when the A/D is active. The maximum voltage at any VCELLx input pin is 19V absolute, but voltages above 18V are not suggested. The individual cell voltages are measured with an integration method to reduce any sudden spikes or fluctuations. The A/D uses an 11-bit resolution mode for these measurements.

Cell voltage inputs are read every measurement period, which is approximately every 500 milliseconds. This could be further extended by the use of Sample mode, where A/D measurements are not activated every measurement period, depending on the configuration of **SampleLimit** and **NSample** values. (See **Section 3.0 "Operational Modes"** for additional information.) For Li Ion, Li-based, or even Lead-Acid applications, up to four (4) series cell voltages may be monitored individually. The highest voltage cell of the stack must be connected to VC(1).

For some applications, the actual cell stack arrangement can be altered accordingly. The PS501 voltage input pins (VCELLx pins) are capable of measuring up to 18V each. Therefore, cell arrangements can be combined and the corresponding cell voltage thresholds can be adjusted. For example, a 2-cell Li lon pack could actually be connected as a single 7.2V cell instead of two 3.6V cells. The values for the cell voltages would all be doubled, for example VCELL1 would equal the sum of two cells and only the VC(1) input pin would be used.

Each VCELLX input circuit contains an internal resistive divider to reduce the external voltage input to a range that the internal A/D circuit can accommodate (150 mV maximum). These dividers are set based on a maximum cell voltage of 4.5 volts. A range of 340 mV with dividers, based on a maximum voltage of 20 volts, is used for pack voltage.

The impedance at each VCELLX input is roughly 100 kOhms, but is only connected to ground (via the VSSA pins) when the actual voltage measurement is occurring. This corresponds to an insignificant amount of capacity drained through this circuit during the brief voltage measurement period, typically 45 ms every 500 ms.

## 2.4.1 IMPEDANCE COMPENSATION

Since accurate measurement of pack voltage and cell voltages are critical to performance, the voltage measurements can be compensated for any impedance in the power path that might affect the voltage measurements.

The EEPROM value **PackResistance** is used to compensate for additional resistance that should be removed.

The equation for the compensation value (in ohms) is:

## **EQUATION 2-3:**

**PackResistance** = Trace Resistance \* 65535

(This is a 2-byte value so the largest value is 1 ohm.)

This requires modification of overall voltage SBData function to compensate for pack resistance and shunt resistance of the current sense resistor. Thus, the previous voltage equation is modified to:

## EQUATION 2-4:

SBData Voltage Value = VC(1) + Measured Current (mA) \* **PackResistance**/65535

The voltage measurement equation is:

#### **EQUATION 2-5:**

 $V(mV) = (V_A/D - COVPack) \times CFVPack/16384$ 

where:

V\_A/D is the internal measurement output

**COVPack** is the "Correction Offset for Pack Voltage" which compensates for any offset error in voltage measurement (since the offset of the A/D is less than the voltage measurement resolution of +/- 16.5 mV, the **COVPack** value is typically zero).

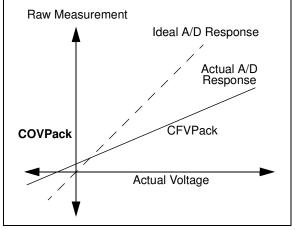
**CFVPack** is the "Correction Factor for Pack Voltage" which compensates for any variance in the actual A/D response versus an ideal A/D response over varying voltage inputs.

The **COVPack** and **CFVPack** are calibration constants that are stored in EEPROM.

VCELL1 and VCELL4 can also be compensated for impedance in the lines connecting to the PS501. **VC1Res** is the resistance between the PS501 and the highest series cell. **VC4Res** is the resistance between the PS501 and the lowest cell. This allows the PS501 to subtract any voltage drop due to current between the cell and the PS501.

Figure 2-2 shows the relationship of the **COVPack** and **CFVPack** values.

## FIGURE 2-2: COVPack AND CFVPack VALUE RELATIONSHIP



In-circuit calibration of the voltage is done at the time of manufacture to obtain absolute accuracy in addition to high resolution. Individual cell voltage measurements can be accurate to within ±20 mV.

The individual cell voltage inputs are also calibrated the same way the pack voltage is. There is one offset value, **COVCeII**, for all individual cells and up to four different correction factors, **CFVCeII1** through **CFVCeII4**, one for each cell input.

## 2.5 Temperature Measurements

The A/D receives input from the internal temperature sensor to measure the temperature. Optionally, an external thermistor can be connected to the VNTC pin which is also monitored by the A/D converter. An output reference voltage for use with an external thermistor is provided on the VREFT pin. The A/D uses an 11-bit resolution mode for the temperature measurements.

A standard 10 kOhms at 25°C Negative-Temperature-Coefficient (NTC) device of the 103ETB type is suggested for the optional external thermistor. One leg of the NTC should be connected to the VREFT pin and the other to both the VNTC pin and a 3.65 kOhms resistor to analog ground (VSSA). The resistor forms the lower leg of a voltage divider circuit. To maintain high accuracy in temperature measurements, a 1% resistor should be used.

A look-up table is used to convert the voltage measurement seen at the VNTC pin to a temperature value. The external thermistor should be placed as close as possible to the battery cells and should be isolated from any other sources of heat that may affect its operation.

Calibration of the temperature measurements involves a correction factor and an offset exactly like the current and voltage measurements. The internal temperature measurement makes use of correction factor **CFTempl** and offset **COTempl**, while the VNTC and VREFT pins for the optional external thermistor make use of correction factor **CFTempE** and offset **COTempE**.

## 3.0 OPERATIONAL MODES

The PS501 operates on a continuous cycle. The frequency of the cycles depends on the power mode selected. There are four power modes: Run, Sample, Sleep and Shelf-Sleep. Each mode has specific entry and exit conditions as listed below.

## 3.1 Run Mode

Whether the PS501 is in Run mode or Sample mode depends on the magnitude of the current. The Run and Sample mode entry-exit threshold is calculated using the EEPROM parameter, **SampleLimit**.

**SampleLimit** is a programmable EEPROM value and **CFCurr** is an EEPROM value set by calibration.

Entry to Run mode occurs when the current is more than +/- **SampleLimit** mA for two consecutive measurements. Run mode may only be exited to Sample mode, not to Sleep mode, when Sample mode is enabled. Exit from Run mode to Sample mode occurs when the converted measured current is less than the +/- **SampleLimit** mA threshold for two consecutive measurements.

Run mode is the highest power consuming mode. During Run mode, all measurements and calculations occur once per measurement period. Current, voltage and temperature measurements are each typically made sequentially during every measurement period.

## 3.2 Sample Mode

Entry to Sample mode occurs when the measured current is less than +/- **SampleLimit** (EE parameter) two consecutive measurements. Sample mode may be exited to either Run mode or Sleep mode.

While in Sample mode, measurements of voltage, current and temperature occur only once per **NSample** counts of measurement periods, where **NSample** is a programmable EEPROM value. Calculations of State-Of-Charge, SMBus requests, etc. still continue at the normal Run mode rate, but measurements only occur once every measurement period x **NSample**. The minimum value for **NSample** is two.

The purpose of Sample mode is to reduce power consumption during periods of inactivity (low rate charge or discharge). Since the analog-to-digital converter is not active, except every **NSample** counts of measurement periods, the overall power consumption is significantly reduced.

#### EXAMPLE 3-1: CONFIGURATION

Measurement period is 500 ms SampleLimit is set to 20 NSample is set to 16

#### Result:

Run/Sample mode entry-exit threshold = 20 mA

During Sample mode, measurements will occur every:

16 measurement periods of 500 mS = every 8 seconds

## 3.3 Low-Voltage Sleep Mode

Entry to Sleep mode can only occur when the measured pack voltage at the VC(1) input is below a preset limit, set by the EEPROM value **SleepVPack** (in mV). Sleep mode may be exited to Run mode, but only when one of the wake-up conditions is satisfied.

While in Sleep mode, no measurements occur and no calculations are made. The fuel gauge display is not operational, no SMBus communications are recognized and only a wake-up condition will permit an exit from Sleep mode. Sleep mode is one of the lowest power consuming modes and is used to conserve battery energy following a complete discharge.

There are two levels of Low-Voltage Sleep mode that can be used, each with a different wake-up criteria. Default Low-Power mode will use 25  $\mu$ A typical and will wake-up when the voltage exceeds the **WakeUp** voltage level. By setting bit 1 of the **WakeUp** register to '1', the Ultra Low-Power mode can be used. This will be entered by low voltage, but wake-up occurs by pulling the SMBus lines high. Ultra Low-Power mode uses less than 1  $\mu$ A.

## 3.4 Shelf-Sleep Mode

Shelf-Sleep mode is used to put the PS501 into Low-Power mode, regardless of voltage level, for long term storage of battery packs. It is entered by an SMBus command. It is exited by the conditions selected in the **WakeUp** register. These can be voltage, GPIO or SMBus activity. If any of these four are selected for wake-up, the Shelf-Sleep mode will be Low-Power mode and will draw 25  $\mu$ A typical. If none of these options are selected and bit 3 of the **WakeUp** register is set, the Shelf-Sleep mode will be Ultra Low-Power mode, which will draw less than 1  $\mu$ A and wake-up will be by pulling SMBus high.

Bit	Name	Function
7	WakelO	Wake-up from I/O Activity
6	WakeBus	Wake-up from SMBus Activity
5	Unused	
4	WakeVolt	Wake-up from Voltage
3	Enable Shelf-Sleep	Use Ultra Low-Power mode for Shelf-Sleep mode. All other bits must be zero.
1	LV Sleep Mode	Use Ultra Low-Power mode as Low-Voltage Sleep mode
0	Zero Remcap	Set remap to zero when entering Low-Voltage Sleep mode

TABLE 3-1: WakeUp EEPROM VALUE

## TABLE 3-2: WakeLevels EEPROM VALUE

WakeUp Voltage (2:0)	Voltage	Purpose
000	6.4V	2 cells Li Ion
001	6.66V	2 cells Li Ion
010	8.88V	2 cells Li Ion
011	9.6V	3 cells Li Ion
100	9.99V	3 cells Li Ion
101	11.1V	3 cells Li Ion
110	12.8V	4 cells Li Ion
111	13.3V	4 cells Li Ion

TABLE 3-3: PC	WER MODE SUMMARY
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Mode	Entry	Exit	Notes
Run	Measured current > preset threshold (set by <b>SampleLimit</b> )	Measured current < preset threshold (set by <b>SampleLimit</b> )	Highest power consumption and accuracy for rapidly changing current.
Sample	Measured current < preset threshold (set by <b>SampleLimit</b> )	Measured current > preset threshold (set by <b>SampleLimit</b> )	Saves power for low, steady current consumption. Not as many measurements needed. Measurements made every <b>NSample</b> periods.
Sleep	VPACK < <b>SleepVPack</b> and in Sample mode	WakeUp voltage level exceeded (Low-Power mode) or SMBus pulled high (Ultra Low-Power mode)	No measurements made.
Shelf-Sleep	SMBus command	WakeUp register conditions met (Low-Power mode) or SMBus pins pulled high (Ultra Low-Power mode)	No measurements made.

## 4.0 CAPACITY MONITORING

The PS501 internal CPU uses the voltage, current and temperature data from the A/D converter, along with parameters and cell models, to determine the state of the battery and to process the SBData function instruction set.

By integrating measured current, monitoring voltages and temperature, adjusting for self-discharge and checking for End-Of-Charge and End-Of-Discharge conditions, the PS501 creates an accurate fuel gauge under all battery conditions.

## 4.1 Capacity Calculations

The PS501 calculates State-Of-Charge and fuel gauging functions using a 'coulomb counting' method, with additional inputs from battery voltage and temperature measurements. By continuously and accurately measuring all the current into and out of the battery cells, along with accurate three-dimensional cell models, the PS501 is able to provide accurate predictions of SOC and run-time.

The capacity calculations consider two separate states: charge acceptance or Capacity Increasing (CI) and discharge or Capacity Decreasing (CD). The CI state only occurs when a charge current larger than the EEPROM **NullCurr** value is measured. Otherwise, while at rest and/or while being discharged, the state is CD. Conditions must persist for at least **NChangeState** measurement periods for a valid state change between CD and CI. A minimum value of 2 is suggested for **NChangeState**.

Regardless of the CI or CD state, self-discharge is also calculated and subtracted from the integrated capacity values. Even when charging, there is still a self-discharge occurring in the battery.

To compensate for known system errors in the capacity calculations, a separate error term is also continuously calculated. This term is the basis for the SBData value of <u>MaxError</u>. Two error values are located in EEPROM. The **CurrError** value is the inherent error in current measurements and should be set based on the selection of a sense resistor and calibration results. The **SelfDischrgErr** value is the error in the parameter tables for self-discharge and depends on the accuracy of the cell chemistry model for self-discharge.

Since the PS501 electronics also drain current from the battery system, another EEPROM value allows even this minor drain to be included in the capacity calculations. The **PwrConsumption** value represents the drain of the IC and associated circuitry, including additional safety monitoring electronics if present. A typical value of 77 represents the module's nominal power consumption, including the PS501 typical consumption.

The total capacity added or subtracted from the battery (change in charge) per measurement period is expressed by the following formula:

## **EQUATION 4-1:**

$\Delta$ Charge = $\Sigma i \Delta t$	(the current integrated over time)
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- **CurrError** (Current Measurement Error)
- PwrConsumption \*  $\Delta t$  (PS501 IDD)
- % of Self-Discharge \* FCC
- SelfDischrgErr (Self-Discharge Error)

The error terms are always subtracted, even though they are +/- errors, so that the fuel gauge value will never be overestimated. Current draw of the PS501 and the self-discharge terms are also always subtracted. The SBData value, <u>MaxError</u>, is the total accumulated error as the gas gauge is running.

The battery current will be precisely measured and integrated in order to calculate total charge removed from or added to the battery. Based on look-up table values, the capacity is adjusted for self-discharge relative to current, temperature and SOC.

## 4.2 Discharge Termination

Discharge termination is determined based on the End-Of-Discharge (EOD) voltage point. The voltage level at which this point occurs can be chosen to be constant, or to change depending on the temperature and discharge rate, since these factors affect the voltage curve and total capacity of the battery. The EOD voltage parameter table predicts the voltage point at which this EOD will be reached, based on discharge rate and temperature.

The PS501 will monitor temperature and discharge rate continuously and update the **Veodx** in real-time. When the voltage measured on the cell is below EOD voltage for the duration of **EODRecheck** x periods (500 ms), a valid EOD has occurred.

When a valid EOD has been reached, the TERMINATE\_DISCHARGE\_ALARM bit (bit 11) in <u>BatteryStatus</u> will be set. This will cause an <u>AlarmWarning</u> condition with this bit set.

Additionally, the REMAINING\_TIME\_ALARM and/or REMAINING\_CAPACITY\_ALARM bits can be set first to give a user defined early warning prior to the TERMINATE\_DISCHARGE\_ALARM. The remaining time alarm will trigger in battery status when the remaining time calculation falls below a threshold set by the SMBus command. The remaining capacity alarm will be set in battery status when the capacity falls below a threshold set by the SMBus command to Remaining TimeAlarm (command code 0x02) or RemainingCapacityAlarm (command code 0x01) to set these values.

## 4.3 Capacity Relearn at Discharge Termination

To maintain accurate capacity prediction ability, the **FullCapacity** value is relearned on each discharge, which has reached a valid EOD after a previous valid fully charged condition (EOC). If a partial charge occurs before reaching a valid EOD, then no relearn will occur. If the discharge rate at EOD is greater than the 'C-rate' adjusted value in **RelearnCurrLim**, then no relearn will occur.

When a valid EOD has been reached, then the error calculations represented by the SBData value of <u>MaxError</u> will be cleared to zero. If appropriate, the relearned value of **FullCapacity** (and <u>FullChargeCapacity</u>) will also be updated at this time.

## 4.4 Discharge Termination Voltage Look-up Table

## 4.4.1 NEAR EMPTY SHUTDOWN POINT

As the graph in Table 4-1 shows, available capacity in the battery varies with temperature and discharge rate. Since the remaining capacity will vary with temperature and discharge rate, a near empty shutdown point will also vary with temperature and discharge rate.

Knowing the discharge rate that occurs in the system during the shutdown process and knowing the temperature can pinpoint the exact save to disk point that will always leave the perfect shutdown capacity. The PS501 uses this information to tailor the gas gauge to the system and the remaining capacity and RSOC fuel gauge function will always go to zero at the efficient shutdown point. The table will use the voltage points at which this happens as the error correction and **FullCapacity** relearn point. This will ensure a relearn point before shutdown occurs and will correct any error in remaining capacity, also to ensure proper shutdown reserve energy.

The shutdown point has to equal the capacity required to shut down the system under the conditions of the shutdown. That is, looking at the curve that represents the actual discharge C-rate that occurs during the system shutdown function, we must stop discharge and initiate shutdown when the system has used capacity equal to that point on the shutdown C-rate curve. This is because no matter what the C-rate is when the shutdown point is reached, the system will automatically switch to the C-rate curve that represents the actual current draw of the shutdown function. So it doesn't matter if the system is in high discharge or low discharge, it will be in "shutdown" discharge conditions when shutdown begins and there must be enough capacity left. An example is a computer's save to disk function.

Table 4-1 shows that the system will always shutdown at the same capacity point regardless of C-rate conditions (since the C-rate of the save to disk procedure is a constant). Thus, we can automatically have an RSOC that is compensated for C-rate; it will go to zero when the capacity used is equal to the point at which shutdown occurs.

Ignoring the effects of temperature, we could mark the capacity used up to the shutdown point of the shutdown curve. All the shutdown voltage would then represent the same capacity and RSOC would always become zero at this capacity and FCC would always equal this capacity, plus the residual capacity of the save to disk curve.

To compensate for temperature, we can look at the series of curves that represent the shutdown C-rate at different temperatures. The PS501 implementation is to measure the temperature and choose a scaled RSOC value that will go to zero at the save to disk point at this temperature, assuming the temperature does not change. If it does change, then an adjustment to RSOC will be needed to make it go to zero at the shutdown point.

Taking temperature into consideration, the amount of capacity that can be used before shutdown is a constant as C-rate changes, but not constant as temperature changes. Thus, in the Look-up Table (LUT), the individual temperature columns will have voltage points that all represent the same capacity used, but the rows across temperature points (C-rate rows) will represent the different capacity used.

To compensate RSOC and RM, interpolation will be used and the compensation adjustment will happen in real-time to avoid sudden drops or jumps. Every time the temperature decreases by one degree, a new interpolated value will be subtracted from RSOC and RM. Every time the temperature increases by one degree, RSOC and RM will be held constant until discharged capacity equals the interpolated value that should have been added to RSOC and RM (to avoid capacity increases during discharge). With this interpolation happening in real-time, there will be no big jumps or extended flat periods as we cross over boundaries in the LUT. This compensation will not begin until after the fully charged status is reset, allowing RSOC to be 100% always when the battery is full.

## 4.5 Age Compensation

The voltage EOD points will be compensated due to the age of the cells. A linear factor, **AgeFactor**, will be applied to the voltage points as a function of <u>CycleCount</u>. The voltage levels will decrease as the battery pack ages to model the flattening of the voltage vs. capacity curve that naturally happens to battery cells.

	< -10°	< 0°	< 10°	< 20°	< 30°	< 40°	< 50°	> 50°
< 0.2C	V1	V2	V3	—				
< 0.5C								
< 0.8C								
< 1.1C								
< 1.4C								
< 1.7C								
< 2.0C								
> 2.0C					_	V62	V63	V64
Capacity	20%	10%	5%	3%	0%	0%	0%	0%

## TABLE 4-1:V\_EOD LOOK-UP TABLE

The above table is an example of the various voltage values that will signal the shutdown points as a function of temperature and discharge rate.

Also shown is the amount of capacity left after shutdown that will compensate RSOC.

Table 4-2 shows the actual names of the values in the EEPROM.

## TABLE 4-2:VALUE NAMES IN THE EEPROM

	TEOD(1)	TEOD(2)	TEOD(3)	TEOD(4)	TEOD(5)	TEOD(6)	TEOD(7)	TEOD(8)
CEOD(1)	VEOD1(1)	VEOD1(2)	VEOD1(3)	VEOD1(4)	VEOD1(5)	VEOD1(6)	VEOD1(7)	VEOD1(8)
CEOD(2)	VEOD2(1)	VEOD2(2)	VEOD2(3)	VEOD2(4)	VEOD2(5)	VEOD2(6)	VEOD2(7)	VEOD2(8)
CEOD(3)	VEOD3(1)	VEOD3(2)	VEOD3(3)	VEOD3(4)	VEOD3(5)	VEOD3(6)	VEOD3(7)	VEOD3(8)
CEOD(4)	VEOD4(1)	VEOD4(2)	VEOD4(3)	VEOD4(4)	VEOD4(5)	VEOD4(6)	VEOD4(7)	VEOD4(8)
CEOD(5)	VEOD5(1)	VEOD5(2)	VEOD5(3)	VEOD5(4)	VEOD5(5)	VEOD5(6)	VEOD5(7)	VEOD5(8)
CEOD(6)	VEOD6(1)	VEOD6(2)	VEOD6(3)	VEOD6(4)	VEOD6(5)	VEOD6(6)	VEOD6(7)	VEOD6(8)
CEOD(7)	VEOD7(1)	VEOD7(2)	VEOD7(3)	VEOD7(4)	VEOD7(5)	VEOD7(6)	VEOD7(7)	VEOD7(8)
CEOD(8)	VEOD8(1)	VEOD8(2)	VEOD8(3)	VEOD8(4)	VEOD8(5)	VEOD8(6)	VEOD8(7)	VEOD8(8)
	FCCP(1)	FCCP(2)	FCCP(3)	FCCP(4)	FCCP(5)	FCCP(6)	FCCP(7)	FCCP(8)

## TABLE 4-3: VALUE DEFINITIONS IN THE EEPROM

TEOD 8 coded bytes	typ: 5, 20, 35, 50, 80, 113, 150, 150	Range: 1-255 per byte		
EOD Temperature boundaries, 8 increasing values of temperature coded as TEODx = (Tcelsius * 10 + 200)/4				
CEOD 8 coded bytes	typ: 19, 32, 48, 64, 77, 90, 109,1 09	Range: 1-255		
EOC C-rate boundaries, 8 increasing values of C-rates coded: CEODx = C-rate * (256/28/RF), where RF is the Rate Factor (RFACTOR) OTP EPROM parameter. For RF = 7, CEODx = C-rate * 64. Thus, a value of 32 is one-half C, etc.				
FCCP coded %	typ: 50, 25, 12, 8, 0, 0, 0	Range: 1-255		
Unusable residual capacity before save to disk, corresponding to temperature, 255 = 100%				
VEOD coded typ: 75 Range: 1-255				
End-Of-Discharge voltage, voltage = 2700 + 4 * VEOD. Cell voltage at which save to disk is signaled.				

## 5.0 CHARGE CONTROL

A SBS configuration normally allows the Smart Battery to broadcast the <u>ChargingVoltage</u> and <u>ChargingCurrent</u> values to the Smart Battery Charger (SMBus address 12 hex) to 'control' when to start charge, stop charge and when to signal a valid 'fully charged' condition. <u>AlarmWarnings</u> are also sent from the Smart Battery (SMBus address 16 hex) to the Smart Battery Charger.

Alternately, the SMBus Host or a "Level 3" Smart Battery Charger may simply read the SBData values for <u>ChargingVoltage</u> and <u>ChargingCurrent</u> from the Smart Battery directly. The Host or "Level 3" Smart Battery Charger is also required to read the SBData value of <u>BatteryStatus</u> to obtain the appropriate alarm and status bit flags. When used in this configuration, the <u>ChargingCurrent</u> and <u>ChargingVoltage</u> broadcasts can be disabled from the Smart Battery by setting the CHARGER\_MODE (bit 14) in the <u>BatteryMode</u> register. The PS501 ICs support all of these functions. (Please refer to the SBS Smart Battery Charger Specification for a definition of the "Level 3" Smart Battery Charger.)

The <u>ChargingCurrent</u> and <u>ChargingVoltage</u> registers contain the maximum charging parameters desired by the particular chemistry, configuration and environmental conditions. The environmental conditions include the measured temperature and the measured cell or pack voltages.

For Li-based systems, <u>ChargingVoltage</u> should be set to the product of the **EOCVolt** and **Cells** values from the EEPROM:

## EQUATION 5-1:

<u>ChargingVoltage</u> = EOCVolt x Cells

The ChargingCurrent value is set to a maximum using the ChrgCurr value from the EEPROM. For Lithium systems, both ChargingCurrent and ChargingVoltage values are maximums. When the current reaches ChrgCurr, it will be held constant at this value. Then, when the voltage reaches ChrgVolt, the current must be reduced so that the voltage will be constant and not exceed the maximum. This is accomplished by setting ChargingCurrent to ChrgCurrOff. For safety reasons, this current change also occurs when the temperature limits are exceeded. When temperature or voltage limits are exceeded, the value of ChargingCurrent changes to the ChrgCurrOff value from the EEPROM. When a valid End-Of-Charge (EOC) condition is detected and a fully charged state is reached, the ChargingCurrent value is set equal to the ChrgCurrOff value.

When <u>ChargingCurrent</u> is set to the **ChrgCurrOff** value, no broadcasts of either <u>ChargingCurrent</u> or <u>Charging-Voltage</u> will occur unless a charge current greater than **NullCurr** is detected by the A/D measurements. Temperature limits are set using the **ChrgMaxTemp**, **DischrgMaxTemp** and **ChrgMinTemp** values from EEPROM. These values represent the temperature limits within which <u>ChargingCurrent</u> will be set to **ChrgCurr**. Temperatures outside these limits will cause <u>ChargingCurrent</u> to be set to **ChrgCurrOff**.

If <u>ChargingCurrent</u> is set to **ChrgCurrOff** and the measured temperature is greater than **DischrgMaxTemp** and less than **ChrgMaxTemp** and a charge current is measured which is significantly larger than the **ChrgCurrOff** value, then <u>ChargingCurrent</u> will be set to **ChrgCurr** unless a fully charged condition has already been reached.

If the CHARGER\_MODE bit in the <u>BatteryMode</u> register is cleared (enabling broadcasts of <u>ChargingCurrent</u> and <u>ChargingVoltage</u>), then these broadcasts will occur every **NChrgBroadcast** measurement cycle.

The Smart Battery Data and Smart Battery Charger Specifications require that <u>ChargingCurrent</u> and <u>ChargingVoltage</u> broadcasts occur no faster than once per 5 seconds and no slower than once per 60 seconds when charging is occurring or desired. This requires that the **NChrgBroadcast** value must be set between 10 and 120. The SMBus Specification also requires that no broadcasts occur during the first 10 seconds after SMBus initialization.

## EXAMPLE 5-1: CONFIGURATION

= = = =	500 msec 100 decimal 2500 decimal 10 decimal 162 decimal 137 decimal 50 decimal
	gingVoltage broadcasts: every 50 seconds
SMB	Bus initialization:
	= = = = 2 har

<u>ChargingCurrent</u> if Temperature > 45°C: 10 mA <u>ChargingCurrent</u> if Temperature < 0°C: 10 mA <u>ChargingCurrent</u> if Temperature < 35°C and > 0°C: 2500 mA

## 5.1 Full Charge Detection Methods

For a typical Lithium Ion constant-current/constantvoltage charge system, the PS501 will monitor the taper current that enters the battery once the battery has reached the final voltage level of the charger. Once the taper current falls to a certain level, indicating that the battery is full, the End-Of-Charge (EOC) will be triggered. Different taper currents will be used for different temperatures. See the parameter explanation in **Section 9.0 "Parameter Setup"** for details.

When a valid fully charged EOC condition is detected, the following actions occur:

- The FULLY\_CHARGED status bit (bit 5) in the SBData value of <u>BatteryStatus</u> is set to '1' to indicate a full condition. (This will remain set until <u>RelativeStateOfCharge</u> drops below the CIrFullyChrg value in EEPROM.)
- RelativeStateOfCharge is set to 100%.
- <u>ChargingCurrent</u> is set to **ChrgCurrOff** value.
- SBData value for <u>MaxError</u> is cleared to zero percent (0%).
- The TERMINATE\_CHARGE\_ALARM bit (bit 14) is set in <u>BatteryStatus</u> and an <u>AlarmWarning</u> broadcast is sent to the SMBus Host and Smart Battery Charger addresses.
- The OverChrg value is incremented for any charge received above 100% after a valid fully charged EOC condition.
- Control flags for internal operations are set to indicate a valid full charge condition was achieved.
- Other <u>BatteryStatus</u> or <u>AlarmWarning</u> flag bits may also be set depending on the conditions causing the EOC.
  - The charge timer, EOCTimer, is exceeded
  - Cell voltage is higher than TCAVolt

## 5.2 Temperature Algorithms

The PS501 SMBus Smart Battery IC provides multiple temperature alarm set points and charging conditions. The following EEPROM parameters control how the temperature alarms and charging conditions operate.

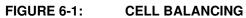
**HighTempAI:** When the measured temperature is greater than **HighTempAI**, the OVER\_TEMP\_ALARM is set. If the battery is charging, then the TERMINATE\_CHARGE\_ALARM is also set.

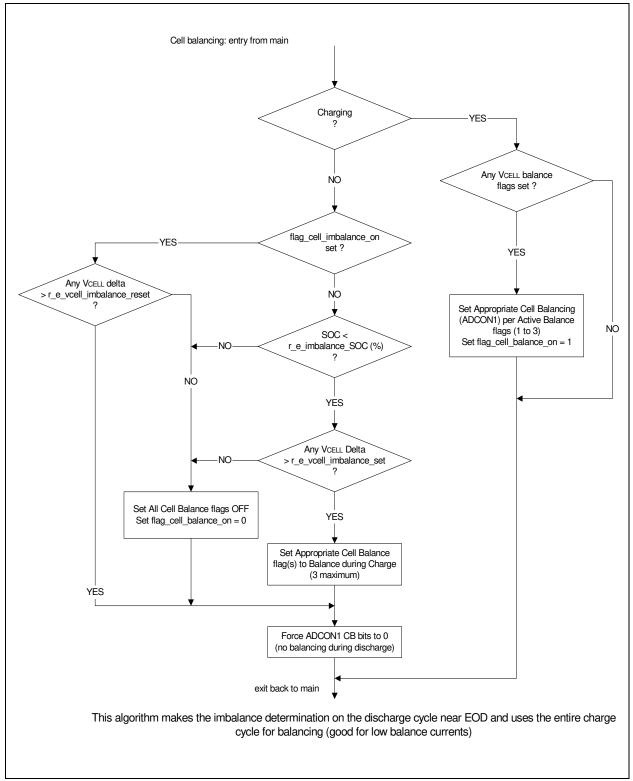
**ChrgMinTemp, DischrgMaxTemp and ChrgMaxTemp:** If the measured temperature is less than **ChrgMinTemp**, the <u>ChargingCurrent</u> is set to **ChrgCurrOff** and the <u>ChargingVoltage</u> is set to **ChrgVolt** to communicate to the charger that the non-charging state of current and voltage should be given. When measured temperature is greater than **ChrgMaxTemp** and the system is charging, or greater than **DischrgMaxTemp** and the system is discharging, then <u>ChargingCurrent</u> is set to **ChrgCurrOff** and the <u>ChargingVoltage</u> is set to **ChrgCurrOff** also. Otherwise, <u>ChargingCurrent</u> = **ChrgCurr** and <u>ChargingVoltage</u> = **ChrgVolt**.

## 6.0 CELL BALANCING

The PS501 has internal cell balancing loads with which to draw extra current away from higher voltage cells. There are internal 500 ohm resistors, which will draw up to 8.4 mA of current from each cell, depending on the cell voltage. The cell balancing algorithm will monitor individual cell voltages and the difference between them. When the difference between any cells exceeds the EEPROM parameter, **VcelldiffMax**, the resistor load will be applied to the higher cell until it is within **VcelldiffresetMax** of the lowest. Cell balancing will only be applied during the charging state to maintain run time during discharge.

Determination of cell balance requirement will be made near End-Of-Charge, when the capacity difference results in a cell voltage difference. Once this determination is made, cell balancing will commence on the charge cycle and remain in effect for the entire charge cycle. Upon discharging, cell balancing will be disabled to preserve run time. Once the near empty point is reached again, determination will be made as to whether correct hysteresis has been reached to disable the cell balancing for the next charge cycle.





## 7.0 GPIO CONFIGURATION

GPIOs can be set up to act as inputs or outputs that are based on conditions involving SBData parameters or GPIO levels compared to constants. This powerful programming model allows for customizing GPIO to set on any possible fuel gauge conditions and reset on any other possible fuel gauge conditions in any groupings.

TABLE /-1: GPIO CONFIGURATIONS	TABLE 7-1:	GPIO CONFIGURATIONS
--------------------------------	------------	---------------------

Name	Length	Definition
GPIOSTATE	2	Initialized default state (positive logic)
GPIODIRECTION	2	Initialized direction: 1 = input 0 = output
GPIOCONFIG	2	GPIO configuration Bit 8: 1 = pull-ups/downs disabled 0 = pull-downs enabled Bits 7:0: if input: 1 = pulled down 0 = pulled up if output: 1 = LED drive (GPIO0-7 only) 0 = standard logic
GPIOPOLARITY	2	"Polarity" mask applied to invert positive logic

GPIOs configured above as standard logic output can be programmed to activate or reset in response to any group of fuel gauge conditions. Each "condition" is defined by 4 bytes.

## TABLE 7-2: GPIO CONDITIONS

Byte	Condition	Definition
Byte 1	Flags	bit 7:1 signifies last condition in groupbit 4:Combination function (1:AND, 0:OR)bit 3:Signed (1) or unsigned (0)bits 2:0Comparison function (0 :>, 1 :<, 2 :=, 3 : AND, 4 : NOR)
Byte 2	Condition selection	x00-x3F – SBData command code x40 – State flags x41 – GPIO flags x42 – VCELL-min x43 – VCELL-max x44 – VCELL-diff x45 – Misc. flags
Byte 3 Byte 4	Condition threshold	Constant

Each condition in the table is processed by applying a "comparison function" to the selected data ("condition selection") and the given constant ("condition threshold"). The result of this operation ("true" or "false") from each condition in the group is combined as dictated by the "AND-OR" "combination function" bit in the flag byte. Because the "AND" function has precedence over the "OR", processing the CG can be described as OR'ing subgroups of ANDs (see Example 7-1 below).

One 8-bit timer (clocked at 500 msec) is associated with all 16 CSF(s). The timer compared to its threshold is an implied "AND" term to the CG (i.e., if processing

of the CG to set the CSF results in "true", the timer is incremented and if timer >= threshold, the SF is set; otherwise, the SF is not set even though the GC is satisfied). If processing of the CG to set the CSF results in "false", the timer is set to zero. The timer is not allowed to increment past the threshold.

The conditions in the order they are stored in memory will build the activation equation until bit 7 of byte 1 is set, signifying the last condition of the group. At that point, the next group of conditions is the Reset equation. When the next to last condition bit is set, a new activation group begins.

## EXAMPLE 7-1: CONDITION GROUPS

#### **Example Condition Group:**

 $(VCELL-min < 3200) \ .AND. \ (CURR > 100) \ .OR. \ (TEMP > 60) \ .AND. \ (CURR > 200) \\ because of precedence the equation would be interpreted: \\ ((VCELL-min < 3200) \ .AND. \ (CURR > 100)) \ .OR. \ ((TEMP > 60) \ .AND. \ (CURR > 200)) \\$ 

## Example Reset Condition Group:

(VCELL-min > 3200) OR (CURR = 200)

Condition	Byte 1	Byte 2	Byte 3, 4	Description
1	x01	x42	x0C80	OR VCELL-min < 3200
2	x10	x0A	x0064	AND CURR > 100
3	x00	x08	x0D02	OR TEMP > 60°C (3330 degrees K * 10)
4	x80	x0A	x00C8	AND CURR > 200 (last condition bit set)
1	x00	x42	x0C80	OR VCELL-min > 3200
2	x82	x0A	x00C8	OR CURR = 200 (last condition bit set)

## TABLE 7-3: CONDITIONS FOR EXAMPLE 7-1

## TABLE 7-4: PARAMETERS

Name	Length	Description
SAFE_GPIO_MASK_00	2	Mask applied to the CSF, if <> 0, GPIO is set
SAFE_GPIO_MASK_01	2	Mask applied to the CSF, if <> 0, GPIO is set
SAFE_GPIO_MASK_02	2	Mask applied to the CSF, if <> 0, GPIO is set
SAFE_GPIO_MASK_03	2	Mask applied to the CSF, if <> 0, GPIO is set
SAFE_GPIO_MASK_04	2	Mask applied to the CSF, if <> 0, GPIO is set
SAFE_GPIO_MASK_05	2	Mask applied to the CSF, if <> 0, GPIO is set
SAFE_GPIO_MASK_06	2	Mask applied to the CSF, if <> 0, GPIO is set
SAFE_GPIO_MASK_07	2	Mask applied to the CSF, if <> 0, GPIO is set
SAFE_GPIO_MASK_08	2	Mask applied to the CSF, if <> 0, GPIO is set
SAFE_GPIO_MASK_09	2	Mask applied to the CSF, if <> 0, GPIO is set
SAFE_GPIO_MASK_10	2	Mask applied to the CSF, if <> 0, GPIO is set
SAFE_GPIO_MASK_11	2	Mask applied to the CSF, if <> 0, GPIO is set
SAFE_TIMER_LIMIT_0	1	Timer threshold/limit (500 msec tics)
SAFE_TIMER_LIMIT_1	1	

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TABLE 7-4: PARAMETERS (CONTINUED)		
Name	Length	Description
SAFE_TIMER_LIMIT_2	1	
SAFE_TIMER_LIMIT_3	1	
SAFE_TIMER_LIMIT_4	1	
SAFE_TIMER_LIMIT_5	1	
SAFE_TIMER_LIMIT_6	1	
SAFE_TIMER_LIMIT_7	1	
SAFE_TIMER_LIMIT_8	1	
SAFE_TIMER_LIMIT_9	1	
SAFE_TIMER_LIMIT_10	1	
SAFE_TIMER_LIMIT_11	1	
SAFE_TIMER_LIMIT_12	1	
SAFE_TIMER_LIMIT_13	1	
SAFE_TIMER_LIMIT_14	1	
SAFE_TIMER_LIMIT_15	1	
SAFE_FLAG_COUNT	1	Number of CSF(s) to process, 0-16 (there must be 2 condition groups (CGs) per CSF)
SAFE_CONDITION	4	Condition (start of table)
	4	Condition
SAFE_CONDITION	4	Condition (end of table)

## TABLE 7-4: PARAMETERS (CONTINUED)

## 7.1 LED Parameters

When configured as LED drivers, the following parameters determine the State-Of-Charge at which each LED will turn on.

TABLE 7-5:	LED PARAMETERS
------------	----------------

Name	Length	Definition
LED_MASK	1	Mask defining GPIO(s) used for LED display(s) (1 = LED)
LED_VALUE_0	1	GPIO 0 SOC value (SOC >= LED_VALUE, LED = on)
LED_VALUE_1	1	GPIO 1 SOC value (SOC >= LED_VALUE, LED = on)
LED_VALUE_2	1	GPIO 2 SOC value (SOC >= LED_VALUE, LED = on)
LED_VALUE_3	1	GPIO 3 SOC value (SOC >= LED_VALUE, LED = on)
LED_VALUE_4	1	GPIO 4 SOC value (SOC >= LED_VALUE, LED = on)
LED_VALUE_5	1	GPIO 5 SOC value (SOC >= LED_VALUE, LED = on)
LED_VALUE_6	1	GPIO 6 SOC value (SOC >= LED_VALUE, LED = on)
LED_VALUE_7	1	GPIO 7 SOC value (SOC >= LED_VALUE, LED = on)
LED_ICHG	2	Current threshold for LED display
LED_DUTYCYCLE	1	Duty cycle of LED drivers
GPIO_SWITCHMASK	2	Mask for switch input(s). If switch is active-high, all bits are '0' except switch pin. If switch is active-low, all bits are '1' except switch pin.
LED_DISPLAY_TIME	1	Number of 500 ms periods LEDs are lit after switch press

## 8.0 SMBus/SBData INTERFACE

The PS501 uses a two-pin System Management Bus (SMBus) protocol to communicate to the Host. One pin is the clock and one pin is the data. The SMBus port responds to all commands in the Smart Battery Data Specification (SBData). To receive information about the battery, the Host sends the appropriate commands to the SMBus port. Certain alarms, warnings and charging information may be sent to the Host by the PS501 automatically. The SMBus protocol is explained in this chapter. The SBData command set is summarized in Table 8-1.

The PS501 SMBus communications port is fully compliant with the System Management Bus Specification, Version 1.1 and supports all previous and new requirements, including bus time-outs (both slave and master), multi-master arbitration and collision detection/recovery. The SMBus port serves as a slave for both read and write functions, as well as a master for write word functions. SMBus slave protocols supported include read word, write word, read block and write block. Master mode supports write word protocols. The PS501 meets and exceeds the Smart Battery Data Specification, Version 1.1/1.1a requirements. The PS501 is compliant with System Management Bus Specification 1.0.

The PS501 fully implements the Smart Battery Data (SBData) Specification v1.1. The SBData Specification defines the interface and data reporting mechanism for an SBS compliant Smart Battery. It defines a consistent set of battery data to be used by a power management system to improve battery life and system run-time, while providing the user with accurate information. This is accomplished by incorporating fixed, measured, calculated and predicted values, along with charging and alarm messages, with a simple communications mechanism between a Host system, Smart Batteries and a Smart Charger.

The PS501 provides full implementation of the SBData set with complete execution of all the data functions, including sub-functions and control bits and flags, compliance to the accuracy and granularity associated with particular data values and proper SMBus protocols and timing.

## 8.1 SBData Function Description

The following subsections document the detailed operation of all of the individual SBData commands.

#### 8.1.1 <u>ManufacturerAccess</u> (0x00)

Internal use only.

#### 8.1.2 <u>RemainingCapacityAlarm</u> (0x01)

Sets or reads the low capacity alarm value. Whenever the remaining capacity falls below the low capacity alarm value, the Smart Battery sends alarm warning messages to the SMBus Host with the REMAINING\_CAPACITY\_ALARM bit set. A low capacity alarm value of '0' disables this alarm.

#### 8.1.3 <u>RemainingTimeAlarm</u> (0x02)

Sets or reads the remaining time alarm value. Whenever the <u>AverageTimeToEmpty</u> falls below the remaining time value, the Smart Battery sends alarm warning messages to the SMBus Host with the REMAINING\_TIME\_ALARM bit set. A remaining time value of '0' disables this alarm.

<b>TABLE 8-1</b> :	SMART BATTERY DATA FUNCTIONS
--------------------	------------------------------

SBData Function Name	Command Code	Access	Parameter Reference	Units
ManufacturerAccess – Write <sup>(1)</sup>	0x00	R/W		
ManufacturerAccess – Read <sup>(1)</sup>	0x00	R/W		
RemainingCapacityAlarm	0x01	R/W	RemCapAl	mAh or 10 mWh
RemainingTimeAlarm	0x02	R/W	RemTimeAl	Minutes
BatteryMode	0x03	R/W		Bit code
AtRate	0x04	Read		mAh or 10 mWh
AtRateTimeToFull	0x05	Read		Minutes
AtRateTimeToEmpty	0x06	Read		Minutes
AtRateOK	0x07	Read		Binary 0/1 (LSB)
Temperature	0x08	Read		0.1°K
Voltage	0x09	Read		mV
Current	0x0a	Read		mA
AverageCurrent	0x0b	Read		mA
MaxError	0x0c	Read		%
RelativeStateOfCharge	0x0d	Read		%
AbsoluteStateOfCharge	0x0e	Read		%
RemainingCapacity	0x0f	Read		mAh or 10 mWh
FullChargeCapacity	0x10	Read		mAh or 10 mWh
RunTimeToEmpty	0x11	Read		Minutes
<u>AverageTimeToEmpty</u>	0x12	Read		Minutes
AverageTimeToFull	0x13	Read		Minutes
ChargingCurrent	0x14	Read	ChrgCurr or ChrgCurrOff	mA
ChargingVoltage	0x15	Read	ChrgVolt or ChrgVoltOff	mV
BatteryStatus	0x16	Read	BatStatus	Bit code
<u>CycleCount</u>	0x17	Read	Cycles	Integer
DesignCapacity	0x18	Read	DesignCapacity	mAh or 10 mWh
DesignVoltage	0x19	Read	DesignVPack	mV
SpecificationInfo	0x1a	Read	SBDataVersion	Coded
ManufactureDate	0x1b	Read	Date	Coded
<u>SerialNumber</u>	0x1c	Read	SerialNumber	Not specified
Reserved	—	—	—	—
ManufacturerName	0x20	Read	MFGName	ASCII text string
<u>DeviceName</u>	0x21	Read	DeviceName	ASCII text string
<u>DeviceChemistry</u>	0x22	Read	Chemistry	ASCII text string
ManufacturerData	0x23	Read	MFGData	Hex string
OptionalMfgFunction4	0x3c	Read	V1 Cell Voltage	mV
OptionalMfgFunction3	0x3d	Read	V2 Cell Voltage	mV
OptionalMfgFunction2	0x3e	Read	V3 Cell Voltage	mV
OptionalMfgFunction1	0x3f	Read	V4 Cell Voltage	mV

Note 1: Reserved.

## 8.1.4 <u>BatteryMode</u> (0x03)

This function selects the various battery operational modes and reports the battery's capabilities, modes and condition.

#### Bit 0: INTERNAL\_CHARGE\_CONTROLLER

Bit set indicates that the battery pack contains its own internal charge controller. When the bit is set, this optional function is supported and the CHARGE\_CONTROLLER\_ENABLED bit will be activated.

#### Bit 1: PRIMARY\_BATTERY\_SUPPORT

Bit set indicates that the battery pack has the ability to act as either the primary or secondary battery in a system. When the bit is set, this optional function is supported and the PRIMARY\_BATTERY bit will be activated.

#### Bit 2-6: Reserved

#### Bit 7: CONDITION\_FLAG

Bit set indicates that the battery is requesting a conditioning cycle. This typically will consist of a full charge to full discharge, back to full charge of the pack. The battery will clear this flag after it detects that a conditioning cycle has been completed.

#### Bit 8: CHARGE\_CONTROLLER\_ENABLED

Bit is set to enable the battery pack's internal charge controller. When this bit is cleared, the internal charge controller is disabled (default). This bit is active only when the INTERNAL\_CHARGE\_CONTROLLER bit is set.

#### Bit 9: PRIMARY\_BATTERY

Bit is set to enable a battery to operate as the primary battery in a system. When this bit is cleared, the battery operates in a secondary role (default). This bit is active only when the PRIMARY\_BATTERY\_SUPPORT bit is set.

#### Bit 10-12: Reserved

#### Bit 13: ALARM\_MODE

Disables the Smart Battery's transmission of the <u>BatteryStatus</u> bits on an alarm condition. Will reset to enabled after 60 seconds.

#### Bit 14: CHARGER\_MODE

Enables or disables the Smart Battery's transmission of <u>ChargingCurrent</u> and <u>ChargingVoltage</u> messages to the Smart Battery Charger. When set, the Smart Battery will not transmit <u>ChargingCurrent</u> and <u>ChargingVoltage</u> values to the charger. When cleared, the Smart Battery will transmit the <u>ChargingCurrent</u> and <u>ChargingVoltage</u> values to the charger when charging is desired.

Bit 15: CAPACITY\_MODE

Indicates if capacity information will be reported in mA/ mAh or 10 mW/10 mWh. When set, the capacity information will be reported in 10 mW/10 mWh. When cleared, the capacity information will be reported in mA/mAh.

## 8.1.5 <u>AtRate</u> (0x04)

<u>AtRate</u> is a value of current or power that is used by three other functions: <u>AtRateTimeToFull</u>, <u>AtRateTimeToEmpty</u> and <u>AtRateOK</u>:

- <u>AtRateTimeToFull</u> returns the predicted time to full charge at the <u>AtRate</u> value of charge current.
- <u>AtRateTimeToEmpty</u> function returns the predicted operating time at the <u>AtRate</u> value of discharge current.
- <u>AtRateOK</u> function returns a Boolean value that predicts the battery's ability to supply the <u>AtRate</u> value of additional discharge current for 10 seconds.

## 8.1.6 <u>AtRateTimeToFull</u> (0x05)

Returns the predicted remaining time to fully charge the battery at the <u>AtRate</u> value (mA). The <u>AtRateTimeToFull</u> function is part of a two-function call set used to determine the predicted remaining charge time at the <u>AtRate</u> value in mA. It will be used immediately after the SMBus Host sets the <u>AtRate</u> value.

## 8.1.7 <u>AtRateTimeToEmpty</u> (0x06)

Returns the predicted remaining operating time if the battery is discharged at the <u>AtRate</u> value. The <u>AtRateTimeToEmpty</u> function is part of a two-function call set used to determine the remaining operating time at the <u>AtRate</u> value. It will be used immediately after the SMBus Host sets the <u>AtRate</u> value.

## 8.1.8 <u>AtRateOK</u> (0x07)

Returns a Boolean value that indicates whether or not the battery can deliver the <u>AtRate</u> value of additional energy for 10 seconds (Boolean). If the <u>AtRate</u> value is zero or positive, the <u>AtRateOK</u> function will always return true. The <u>AtRateOK</u> function is part of a twofunction call set used by power management systems to determine if the battery can safely supply enough energy for an additional load. It will be used immediately after the SMBus Host sets the <u>AtRate</u> value.

## 8.1.9 <u>Temperature</u> (0x08)

Returns the cell pack's internal temperature in units of  $0.1^{\circ}$ K.

## 8.1.10 <u>Voltage</u> (0x09)

Returns the pack voltage (mV).

## 8.1.11 <u>Current</u> (0x0a)

Returns the current being supplied (or accepted) through the battery's terminals (mA).

## 8.1.12 <u>AverageCurrent</u> (0x0b)

Returns a one-minute rolling average based on at least 60 samples of the current being supplied (or accepted) through the battery's terminals (mA).

## 8.1.13 <u>MaxError</u> (0x0c)

Returns the expected margin of error (%) in the State-Of-Charge calculation. For example, when <u>MaxError</u> returns 10% and <u>RelativeStateOfCharge</u> returns 50%, the <u>RelativeStateOfCharge</u> is actually between 50% and 60%. The <u>MaxError</u> of a battery is expected to increase until the Smart Battery identifies a condition that will give it higher confidence in its own accuracy. For example, when a Smart Battery senses that it has been fully charged from a fully discharged state, it may use that information to reset or partially reset <u>MaxError</u>. The Smart Battery can signal when <u>MaxError</u> has become too high by setting the CONDITION\_FLAG bit in <u>BatteryMode</u>.

## 8.1.14 <u>RelativeStateOfCharge</u> (0x0d)

Returns the predicted remaining battery capacity expressed as a percentage of <u>FullChargeCapacity</u> (%).

## 8.1.15 <u>AbsoluteStateOfCharge</u> (0x0e)

Returns the predicted remaining battery capacity expressed as a percentage of <u>DesignCapacity</u> (%). Note that <u>AbsoluteStateOfCharge</u> can return values greater than 100%.

## 8.1.16 <u>RemainingCapacity</u> (0x0f)

Returns the predicted remaining battery capacity. The <u>RemainingCapacity</u> value is expressed in either current (mAh) or power (10 mWh), depending on the setting of the <u>BatteryMode</u>'s CAPACITY\_MODE bit.

## 8.1.17 <u>FullChargeCapacity</u> (0x10)

Returns the predicted pack capacity when it is fully charged. It is based on either current or power, depending on the setting of the <u>BatteryMode</u>'s CAPACITY\_MODE bit.

## 8.1.18 <u>RunTimeToEmpty</u> (0x11)

Returns the predicted remaining battery life at the present rate of discharge (minutes). The <u>RunTimeToEmpty</u> value is calculated based on either current or power, depending on the setting of the <u>BatteryMode</u>'s CAPACITY\_MODE bit. This is an important distinction because use of the wrong calculation mode may result in inaccurate return values.

## 8.1.19 <u>AverageTimeToEmpty</u> (0x12)

Returns a one-minute rolling average of the predicted remaining battery life (minutes). The <u>AverageTimeToEmpty</u> value is calculated based on either current or power, depending on the setting of the

<u>BatteryMode</u>'s CAPACITY\_MODE bit. This is an important distinction because use of the wrong calculation mode may result in inaccurate return values.

## 8.1.20 AverageTimeToFull (0x13)

Returns a one-minute rolling average of the predicted remaining time until the Smart Battery reaches full charge (minutes).

## 8.1.21 ChargingCurrent (0x14)

Sets the maximum charging current for the Smart Charger to charge the battery. This can be written to the Smart Charger from the Smart Battery or requested by the Smart Charger from the battery.

## 8.1.22 ChargingVoltage (0x15)

Sets the maximum charging voltage for the Smart Charger to charge the battery. This can be written to the Smart Charger from the Smart Battery or requested by the Smart Charger from the battery.

## 8.1.23 BatteryStatus (0x16)

Returns the Smart Battery's status word (flags). Some of the <u>BatteryStatus</u> flags, like REMAINING\_CAPACITY\_ALARM and REMAINING\_TIME\_ALARM, are calculated based on either current or power, depending on the setting of the <u>BatteryMode</u>'s CAPACITY\_MODE bit. This is important because use of the wrong calculation mode may result in an inaccurate alarm. The <u>BatteryStatus</u> function is used by the power management system to get alarm and status bits, as well as error codes, from the Smart Battery. This is basically the same information returned by the SBData <u>AlarmWarning</u> function except that the <u>AlarmWarning</u> function sets the error code bits all high before sending the data. Also, information broadcasting is disabled in the PS501.

#### **Battery Status Bits:**

- bit 15: OVER CHARGED ALARM
- bit 14: TERMINATE\_CHARGE\_ALARM
- bit 13: Reserved
- bit 12: OVER\_TEMP\_ALARM
- bit 11: TERMINATE\_DISCHARGE\_ALARM
- bit 10: Reserved
- bit 9: REMAINING\_CAPACITY\_ALARM
- bit 8: REMAINING\_TIME\_ALARM
- bit 7: INITIALIZED
- bit 6: DISCHARGING
- bit 5: FULLY\_CHARGED
- bit 4: FULLY\_DISCHARGED

The Host system assumes responsibility for detecting and responding to Smart Battery alarms by reading the <u>BatteryStatus</u> to determine if any of the alarm bit flags are set. At a minimum, this requires the system to poll the Smart Battery <u>BatteryStatus</u> every 10 seconds at all times the SMBus is active.

## 8.1.24 <u>CycleCount</u> (0x17)

<u>CycleCount</u> is updated to keep track of the total usage of the battery. <u>CycleCount</u> is increased whenever an amount of charge has been delivered to, or removed from, the battery equivalent to the full capacity.

## 8.1.25 <u>DesignCapacity</u> (0x18)

Returns the theoretical capacity of a new pack. The <u>DesignCapacity</u> value is expressed in either current or power, depending on the setting of the <u>BatteryMode</u>'s CAPACITY\_MODE bit.

## 8.1.26 DesignVoltage (0x19)

Returns the theoretical voltage of a new pack (mV).

## 8.1.27 <u>SpecificationInfo</u> (0x1a)

Returns the version number of the Smart Battery specification the battery pack supports.

## 8.1.28 <u>ManufactureDate</u> (0x1b)

This function returns the date the cell pack was manufactured in a packed integer. The date is packed in the following fashion: (year-1980) \* 512 + month \* 32 + day.

## 8.1.29 <u>SerialNumber</u> (0x1c)

This function is used to return a serial number. This number, when combined with the <u>ManufacturerName</u>, the <u>DeviceName</u> and the <u>ManufactureDate</u>, will uniquely identify the battery.

## 8.1.30 <u>ManufacturerName</u> (0x20)

This function returns a character array containing the battery manufacturer's name.

## 8.1.31 <u>DeviceName</u> (0x21)

This function returns a character string that contains the battery's name.

## 8.1.32 <u>DeviceChemistry</u> (0x22)

This function returns a character string that contains the battery's chemistry. For example, if the <u>DeviceChemistry</u> function returns "NiMH", the battery pack would contain nickel metal hydride cells. The following is a partial list of chemistries and their expected abbreviations. These abbreviations are not case sensitive.

Lead Acid: PbAc Lithium Ion: LION Nickel Cadmium: NiCd Nickel Metal Hydride: NiMH Nickel Zinc: NiZn Rechargeable Alkaline-Manganese: RAM Zinc Air: ZnAr

## 8.1.33 <u>ManufacturerData</u> (0x23)

This function allows access to the manufacturer data contained in the battery (data).

#### 8.1.34 OptionalMfgFunction

The PS501 includes new SBData functions using the <u>OptionalMfgFunction</u> command codes. The command codes, 3C hex to 3F hex, report the individual cell voltages as measured by the analog-to-digital converter. These voltages are reported in mV and are calculated to include compensation for calibration and sense resistance voltage drops. Only one cell voltage is measured per measurement cycle (depending on Run or Sample mode operation).

Rapid voltage changes will see some variation in voltages due to the delay of measurement. These voltage values may be used for cell balancing or other functions as the Host system may desire.

Battery Status	Set Condition	Clear Condition
FULLY_CHARGED bit	Set at End-Of-Charge Condition: Charge FET off AND Any VC(x) input > 4.175V AND IAVG < EOC_IAVG for <b>ChrgCntrlTimer</b> number of consecutive counts	<u>RelativeStateOfCharge</u> ( ) < <b>CIrFullyChrg</b> (default RSOC = 80%)
OVER_CHARGED_ALARM bit	VCELLx > <b>TCAVolt</b> (default 4.5V/Cell)	All VCELLX < TCAVolt
TERMINATE_CHARGE_ALARM bit	VCELLX > <b>TCAVolt</b> (default 4.5V/Cell) OR Charging Temperature () > <b>ChrgMaxTemp</b> (default 60°C) OR FULLY_CHARGED bit = 1	All VCELLx < <b>TCAVolt</b> AND <u>Temperature</u> ( ) < <b>ChrgMaxTemp</b> AND <u>Current</u> ( ) = < 0
OVER_TEMP_ALARM bit	Temperature () > HighTempAI (default 55°C)	Temperature () < HighTempAl
TERMINATE_DISCHARGE_ALARM bit	Primary Method: VCELLx < VEOD1 (per look-up table) AND Above condition continues for <b>NearEODRecheck</b> time. Secondary Method: VCELLx < VEOD2 (default 3.1V/Cell) AND Above condition continues for <b>EODRecheck</b> time.	Primary Method: All VCELLx > VEOD1 OR <u>Current</u> () > 0 Secondary Method: All VCELLx > VEOD2 OR <u>Current</u> () > 0
REMAINING_CAPACITY_ALARM bit	<u>RemainingCapacity</u> ( ) < <u>RemainingCapacityAlarm</u> ( )	<u>RemainingCapacity</u> ( ) > <u>RemainingCapacityAlarm</u> ( )
REMAINING_TIME_ALARM bit	<u>AverageTimeToEmpty</u> ( ) < <u>RemainingTimeAlarm</u> ( )	<u>AverageTimeToEmpty</u> () > <u>RemainingTimeAlarm</u> ()
FULLY_DISCHARGED bit	<u>RemainingCapacity</u> () = 0	<u>RelativeStateOfCharge</u> () > <b>ClrFullyDischrg</b> (default RSOC = 20%)

## TABLE 8-2: PS501 ALARMS AND STATUS SUMMARY

## TABLE 8-3: Temperature, ChargingCurrent() AND ChargingVoltage() SUMMARY

Temperature ( ) > HighTempAI (default 60°C)		
Charging	Discharging	
TERMINATE_CHARGE_ALARM and OVER_TEMP_ALARM	OVER_TEMP_ALARM	
Cleared <u>Temperature</u> ( ) < HighTempAI		

<u>Temperature</u> ( ) > ChrgMaxTemp (default 50°C)	<u>Temperature</u> ( ) > DischrgMaxTemp (default 65°C)
Charging	Discharging
<u>ChargingCurrent</u> ( ) = ChrgCurrOff <u>ChargingVoltage</u> ( ) = ChrgVoltOff	

<u>Temperature</u> ( ) < ChrgMinTemp						
	<u>ChargingCurrent</u> () = ChrgCurrOff <u>ChargingVoltage</u> () = ChrgVolt					
For all other temperature conditions:	<u>ChargingCurrent</u> () = ChrgCurr <u>ChargingVoltage</u> () = ChrgVolt					

## 9.0 PARAMETER SETUP

This section documents all of the programmable parameters that are resident in the EEPROM. The Parameter Set is organized into the following functional groups:

- 1. Pack Information
- 2. Capacity Calculations
- 3. EOD and FCC Relearn
- 4. Charge Control
- 5. GPIO
- 6. PS501 Settings
- 7. SBData Settings
- 8. Calibration

Parameter Name	# Bytes	Lower Limit	Upper Limit	Typical Value	Operational Description
BatStatus	1	0	255	b01000000	Lower byte of SBData register for <u>BatteryStatus</u> .
Cells	1	0	255	4	Number of cells in the battery pack.
Chemistry	4	_		LION	SBS data for chemistry. Can be any ASCII string. The chemistry name can be programmed here and retrieved with the SBData <u>DeviceChemistry</u> command.
Date	2	0	65535	0x3042	SBData value for <u>ManufactureDate</u> . The date of manufacture of the battery pack can be programmed here and retrieved with the SBData <u>ManufactureDate</u> command. Coding: Date = (Year-1980) x 512 + Month x 32 + Day
DesignCapacity	2	0	65535	4400	SBData value for <u>DesignCapacity</u> . This is the first capacity loaded into the <u>FullChargeCapacity</u> upon power-up.
DesignVPack	2	0	65535	14800	SBData value for <u>DesignVoltage</u> .
DeviceName	8	_	—	PS501	SBData value for <u>DeviceName</u> . Can be any ASCII string. The battery circuit device name can be programmed here and retrieved with the SBData <u>DeviceName</u> command.
MFGData	4	_	_	0x0	SBS string for ManufacturerData.
MFGName	10		—	Microchip	SBS string for <u>ManufacturerName</u> . Can be any ASCII string, typically the name of the battery pack manufacturer. Length of string is defined by <u>MfgNameLength</u> .
PackRes	2	0	65535	65	Resistance of pack.
PW1	2	0	65535	AA4D	First password for the battery pack lock.
PW2	2	0	65535	D4AA	Second password for the battery pack lock.
SpecInfo	2	0	65535	33	Specification info according to SBS Spec. 0011, refers to Smart Battery Specification version 1.1.
SerialNumber	2	0	65535	100	SBData value for <u>SerialNumber</u> . The serial number of the battery pack can be programmed here and retrieved with the SBData <u>SerialNumber</u> command.

## TABLE 9-1:PACK INFORMATION